

05-14-2001

Docket No.: TSL1647

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(Rev. 6-93)
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U.S. DEPARTMENT OF COMMERCE
Patent and Trademark Office

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To the Honorable Commissioner of Patents and Trademarks: Please record the attached original documents or copy thereof.

1. Name of conveying party(ies):

Haruhiko Furukawa
Yoshitsugu Morita

05/03/01

2. Name and address of receiving party(ies):

Name: Dow Corning Toray Silicone Company, LTD.

Address: 4th Floor, AIG Building, 1-1-3, Marunouchi,

Chiyoda-ku,

Additional names(s) of conveying party(ies)

☐ Yes ☒ No

3. Nature of conveyance:

☒ Assignment☐ Merger☐ Security Agreement☐ Change of Name☐ Other

City: Tokyo 100-0005

State/Prov.:

Country: Japan

ZIP:

Execution Date: March 30, 2001

Additional name(s) & address(es)

☐ Yes ☒ No

4. Application number(s) or registration numbers(s):

If this document is being filed together with a new application, the execution date of the application is: March 30, 2001

Patent Application No.

Filing date

B. Patent No.(s)

09/848757

Additional numbers

☐ Yes ☒ No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Alan Zombeck

Registration No. 45,260

Address: Dow Corning Corporation

Intellectual Property Dept. - Mail CO1232

2200 W. Salzburg, P. O. Box 994

City: Midland

State/Prov.: MI

Country: US

ZIP: 48686-0994

6. Total number of applications and patents involved:

1

7. Total fee (37 CFR 3.41):.....\$ 40.00

☐ Enclosed - Any excess or insufficiency should be credited or debited to deposit account☒ Authorized to be charged to deposit account

8. Deposit account number:

04-1520

05/14/2001 6TON11 00000078 041520 09848757

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9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Alan Zombeck

Name of Person Signing

Signature

May 2, 2001

Date

3

Total number of pages including cover sheet, attachments, and

PATENT

REEL: 011786 FRAME: 0026

ASSIGNMENT

WHEREAS We, Haruhiko Furukawa, and Yoshitsugu Morita have invented certain new and useful improvements in

THERMOPLASTIC ELASTOMER COMPOSITION, METHOD OF PREPARATION, AND MOLDED PRODUCTS THEREOF

for which application for United States Letters Patent has been executed by us on the
____ 30th ____ day of ____ March ____, 2001; and,

WHEREAS, DOW CORNING TORAY SILICONE COMPANY, LTD., of 4th Floor, AIG Building, 1-1-3, Marunouchi, Chiyoda-ku, Tokyo 100-0005, Japan, is desirous of acquiring the said invention and said application and any and all Letters Patent that may be obtained therefor or thereupon, and all reissues and extensions thereof;

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN, be it known that for and in consideration of the sum of ____ 250 ____ Yen, and other good and valuable considerations, to us in hand paid by the said DOW CORNING TORAY SILICONE COMPANY, LIMITED, the receipt of which is hereby acknowledged, we have sold, assigned, transferred and set over and by these presents do sell, assign, transfer and set over unto the said DOW CORNING TORAY SILICONE COMPANY, LTD., its successors, and assigns, the full and exclusive right, title and interest in and to said invention and said application for Letters Patent of the United States therefore, and in and to any Divisions and Continuations thereof and in and to any and all United States Letters Patent and reissues and extensions thereof that may be issued for the said invention, to have and to hold for its own use and behoof and the use and behoof of its successors and assigns as fully and entirely as the same might be enjoyed by us if this sale and assignment had not been made; and

HEREBY AUTHORIZE and request the Commissioner of Patents and Trademarks to issue the said Letters Patent and any reissues and extensions thereof to the said DOW CORNING TORAY SILICONE COMPANY, LTD. as assigns of the entire right, title and interest in and to the said invention and said application and Letters Patent issued therefore or thereupon; and

HEREBY AGREE to execute all instruments and documents within our power which may be necessary for the carrying out of this assignment in full; and to execute any divisional or continuing application or applications which may be necessary or proper to obtain full protection on the invention hereby assigned; and to execute any and all supplemental oaths and preliminary statements should the same be proper and necessary in the prosecution of the aforesaid applications; and

HEREBY FURTHER ASSIGN unto the said DOW CORNING TORAY SILICONE COMPANY, LIMITED, its successors, and assigns, the whole right, title and interest in and to the invention disclosed in the said application throughout all countries foreign to the United States, and do hereby ratify any acts of the said DOW CORNING TORAY SILICONE COMPANY, LIMITED, its successors and assigns, in applying for patents therefore in its own name in countries where such procedure is proper and do agree to execute applications for said invention in the several countries where it is necessary that the same be executed by the inventors, and to execute assignments of such applications and the patents to be obtained therefore to the said DOW CORNING TORAY SILICONE COMPANY, LIMITED, its successors and assigns.

IN WITNESS WHEREOF I have hereunto set my hand

Haruhiko Furukawa
Haruhiko Furukawa

Dated: March 30, 2001

This is to certify that Haruhiko Furukawa has signed this document in my presence this 30th day of March, 2001, Japan.

Katsuyoshi Nakasuji
Signature of Witness
Katsuyoshi Nakasuji

IN WITNESS WHEREOF I have hereunto set my hand

Yoshitsugu Morita
Yoshitsugu Morita

Dated: March 30, 2001

This is to certify that Yoshitsugu Morita has signed this document in my presence this 30th day of March, 2001, Japan.

Katsuyoshi Nakasuji
Signature of Witness
Katsuyoshi Nakasuji